

# Dual N-channel MOSFET

## ELM16800EA-S

### ■ General description

ELM16800EA-S uses advanced trench technology to provide excellent  $R_{ds(on)}$  and low gate charge.

### ■ Features

- $V_{ds}=30V$
- $I_d=3.4A$  ( $V_{gs}=10V$ )
- $R_{ds(on)} < 60m\Omega$  ( $V_{gs}=10V$ )
- $R_{ds(on)} < 75m\Omega$  ( $V_{gs}=4.5V$ )
- $R_{ds(on)} < 115m\Omega$  ( $V_{gs}=2.5V$ )

### ■ Maximum absolute ratings

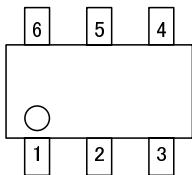
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	$V_{ds}$	30	V	
Gate-source voltage	$V_{gs}$	$\pm 12$	V	
Continuous drain current Ta=25°C	$I_d$	3.4	A	1
Ta=70°C		2.7		
Pulsed drain current	$I_{dm}$	20	A	2
Power dissipation Ta=25°C	$P_d$	1.15	W	1
Ta=70°C		0.73		
Junction and storage temperature range	$T_j, T_{stg}$	-55 to 150	°C	

### ■ Thermal characteristics

Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	t≤10s	$R_{\theta ja}$	78	110	°C/W	1
Maximum junction-to-ambient	Steady-state		106	150	°C/W	
Maximum junction-to-lead	Steady-state	$R_{\theta jl}$	64	80	°C/W	3

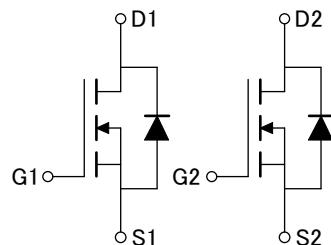
### ■ Pin configuration

SOT-26 (TOP VIEW)



Pin No.	Pin name
1	GATE1
2	SOURCE2
3	GATE2
4	DRAIN2
5	SOURCE1
6	DRAIN1

### ■ Circuit



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### ■ Electrical characteristics

$T_a=25^\circ C$

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
<b>STATIC PARAMETERS</b>						
Drain-source breakdown voltage	BVdss	$I_d=250\mu A, V_{gs}=0V$	30			V
Zero gate voltage drain current	Idss	Vds=24V			1	$\mu A$
		Vgs=0V	Tj=55°C		5	
Gate-body leakage current	Igss	Vds=0V, Vgs=±12V			100	nA
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=250 $\mu A$	0.6	1.0	1.4	V
On state drain current	Id(on)	Vgs=4.5V, Vds=5V	20			A
Static drain-source on-resistance	Rds(on)	Vgs=10V		50	60	$m\Omega$
		Id=3.4A	Tj=125°C	66	80	
		Vgs=4.5V, Id=3A		60	75	$m\Omega$
		Vgs=2.5V, Id=2A		88	115	$m\Omega$
Forward transconductance	Gfs	Vds=5V, Id=3A		7.8		S
Diode forward voltage	Vsd	Is=1A, Vgs=0V		0.8	1.0	V
Max. body-diode continuous current	Is				1.5	A
<b>DYNAMIC PARAMETERS</b>						
Input capacitance	Ciss	Vgs=0V, Vds=15V, f=1MHz		390.0		pF
Output capacitance	Coss			54.5		pF
Reverse transfer capacitance	Crss			41.0		pF
Gate resistance	Rg	Vgs=0V, Vds=0V, f=1MHz		3		$\Omega$
<b>SWITCHING PARAMETERS</b>						
Total gate charge	Qg	Vgs=4.5V, Vds=15V, Id=3.4A		4.96		nC
Gate-source charge	Qgs			0.80		nC
Gate-drain charge	Qgd			1.72		nC
Turn-on delay time	td(on)	Vgs=10V, Vds=15V RI=4.7 $\Omega$ , Rgen=6 $\Omega$		6.8		ns
Turn-on rise time	tr			3.6		ns
Turn-off delay time	td(off)			35.2		ns
Turn-off fall time	tf			13.7		ns
Body diode reverse recovery time	trr	If=3.4A, dl/dt=100A/ $\mu s$		11.4		ns
Body diode reverse recovery charge	Qrr	If=3.4A, dl/dt=100A/ $\mu s$		6.0		nC

### NOTE :

1. The value of  $R_{\theta ja}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board of 2oz. Copper, in still air environment with  $T_a=25^\circ C$ . The value in any given applications depends on the user's specific board design, The current rating is based on the  $t \leq 10s$  thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The  $R_{\theta ja}$  is the sum of the thermal impedance from junction to lead  $R_{\theta jl}$  and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80  $\mu s$  pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_a=25^\circ C$ . The SOA curve provides a single pulse rating.

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## ■ Typical electrical and thermal characteristics

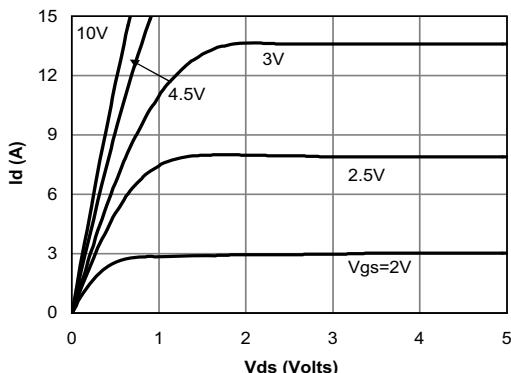


Fig 1: On-Region Characteristics

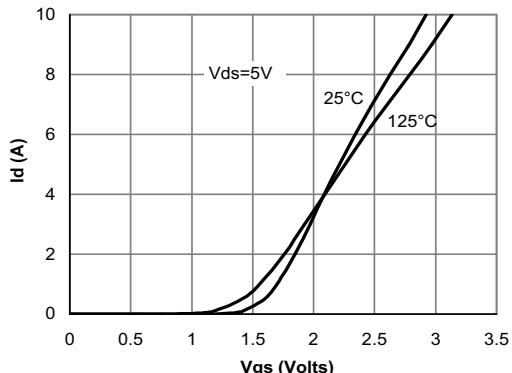


Figure 2: Transfer Characteristics

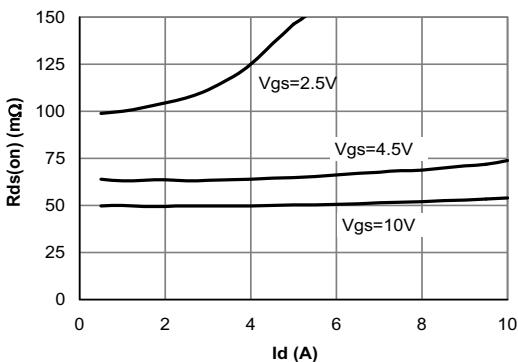


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

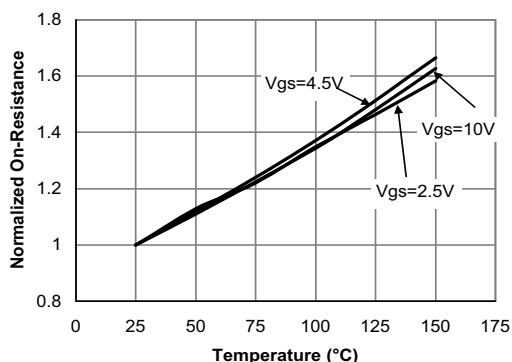


Figure 4: On-Resistance vs. Junction Temperature

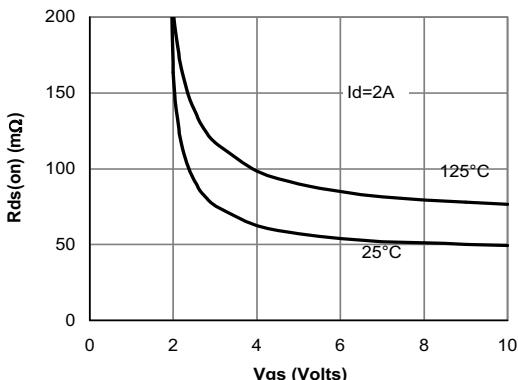


Figure 5: On-Resistance vs. Gate-Source Voltage

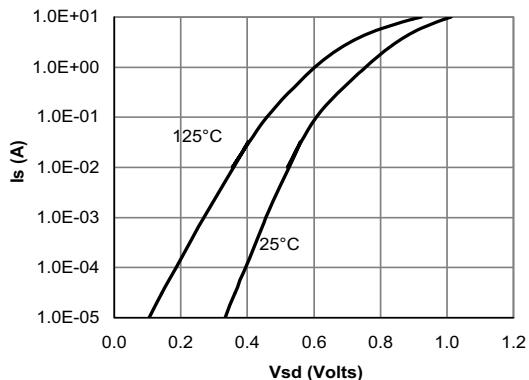


Figure 6: Body-Diode Characteristics

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